

International Trade Fair for Components, Assemblies, Electronics Production and Display Technologies

# electronicAsia 2010



## Connecting Tomorrow's World...Today

### 13 - 16 October 2010

Hong Kong Convention and Exhibition Centre

In conjunction with HKTDC Hong Kong Electronics Fair (Autumn Edition)

For Official Use

A/N

O/N

B/N

## Part I Space Application



Please use English to complete this form in print. The information will be used in the Fair Catalogue.

Company Name: \_\_\_\_\_

Contact Person:  Mr  Ms \_\_\_\_\_

Title: \_\_\_\_\_

Address: \_\_\_\_\_  
\_\_\_\_\_

Postal Code: \_\_\_\_\_ Country/Region: \_\_\_\_\_

Telephone No.: \_\_\_\_\_  
Country code Area code Tel No.

Fax No.: \_\_\_\_\_

E-mail: \_\_\_\_\_

Web site: \_\_\_\_\_

Products: \_\_\_\_\_  
\_\_\_\_\_

Brand Name(s): \_\_\_\_\_

Will your company source at the fair?  Yes  No

### STAND REQUEST

Option	Standard Booth	Price per Booth		No. of Booth(s)		Rental (A)
A.	9sq.m. Standard Booth	US\$4,311	X		=	

Option	Premium Booths – 9sqm	Price per Booth		No. of Booth(s)		Rental (A)
B.	Option-A	US\$5,679	X		=	
C.	Option-B	US\$5,868	X		=	

Option	Raw Space	Price per Sq.m.		Size (Sq.m.)		Rental (A)
D.	<ul style="list-style-type: none"><li>Exhibitor needs to build the stand themselves</li><li>min. 36sq.m.</li><li>carpeted floor</li></ul>	US\$412	X		=	

We hereby apply for joining **electronicAsia 2010**. We agree to abide by the Terms of Application and Exhibition Rules & Regulations set out by the Organiser. We understand that the above information will be included into the Organiser's databank and the Organiser can make use of our information for trade promotion purposes or on-pass to third parties for promotion of electronicAsia 2010. We accept that the Organiser bears no responsibility for any error or omission.

We hereby certify that the information given above is all true and correct. If any of the information is found to be incorrect or misleading, the Organiser reserves the right to terminate our participation in the fair and we cannot make any claim against the Organiser for refund of any monies paid.

If you do not wish to have your information on-passed to third parties for promotion of electronicAsia, excluding the production of the official fair printed matters, please check against the box.

Name (in print): \_\_\_\_\_ Position: \_\_\_\_\_

Stamp & Authorized Signature: \_\_\_\_\_ Date: \_\_\_\_\_



## 10 Passive Components

- Inductor
- Capacitors / Condensers
- Resistor
- Passive Components
- Piezo Electric Component
- Magnetic & Electronic Ceramic Products

## 11 Motors / Drives

- Motors
- Gear For Electrical Parts
- Magnetic Actuators
- Actuators
- Actuator Accessories

## 12 Assemblies and Subsystems

- Assembly / PCB Assembly & Subsystem
- Automotive Electronic Assemblies
- Assemblies for Measurement Applications
- Assemblies for Control Applications
- Printer Assemblies
- DDI & Other Network Technology Components Assemblies
- Electronics Protection Device (EMI/ESD) Assemblies
- Hybrid Module Assemblies (Incl Multi-Chip Modules)
- Thermal Management Assemblies

## 13 Microwave Technology

- Microwave Antennas
- Microwave Antennas accessories
- Signal Transmission Components
- RF Switches
- Signal Influencing Components
- Passive Microwave Components
- Microwave Components, active
- Electronic Filter
- Resonator
- Oscillator

## 14 Powersupplies

- Transformer
- Coilware For Specific Application
- Accessories for coilware
- DC Output
- AC Outout
- UPS / Power Supply
- Special Power Supply
- Battery
- Power Supplies Accessories

## 15 Manufacturing Equipment and Logistics for Semiconductors and Components

- Wafer Front-End Processing Manufacturing Equipment
- Wafer Back-End Processing Manufacturing Equipment
- Coilware Manufacturing Equipment

- Lumped Components Manufacturing Equipment
- Clean Room Technology & Manufacturing Equipment
- Conveyors for Semiconductors Manufacturing
- Process-Control Software For Semiconductors Manufacturing

## 16 Manufacturing Equipment and Logistics for Microsystem Technology

- Substrate Materials Manufacturing Equipment for Microsystem Technology
- Manufacturing Equipment For Mask and Artwork Generation in Microsystem Technology
- Manufacturing Equipment for Microsystems Lithography
- Manufacturing Equipment for Bonding in Microsystem
- Manufacturing Equipment for Micro Assembly
- Manufacturing Equipment for Microsystem Housings

## 17 Manufacturing Equipment and Logistics for PCBs and Other Circuit Carriers

- Manufacturing Equipment For Base Materials of Circuit Carriers
- Manufacturing Equipment for Circuit-Printing Tools and Photomasters
- Mechanical Processing Equipment for Circuit Carriers
- Manufacturing Equipment for Generating Circuit Structure
- Manufacturing Equipment for Chemical and Electroplate Processing
- Heat Dry Treatment Equipment
- MID Production Equipment
- Conveyors for Circuit Carriers Manufacturing
- Process-Control Software for PCB Production

## 18 Manufacturing Equipment and Logistics for Assemblies, Modules and Hybrids

- Component Preparation Equipment For Assemblies, Modules and Hybrids
- Gluing Equipment For Assemblies, Modules and Hybrids
- Insertion Technology Equipment For Assemblies, Modules and Hybrids
- Soldering Technology Equipment For Assemblies, Modules and Hybrids
- Assemblies, Modules and Hybrids Manufacturing Equipment for Detachable Connections
- Assemblies, Modules and Hybrids Manufacturing Equipment for Permanent Connections
- Repair and Reworking Equipment For Assemblies, Modules and Hybrids Manufacturing
- Assemblies, Modules and Hybrids Manufacturing Tools
- Protective Coating and Potting For Assemblies, Modules and Hybrids Manufacturing

- Hybrids Manufacturing Equipment
- Housings Manufacturing Equipment
- Conveyors For Assemblies, Modules and Hybrids Manufacturing
- Process-Control Software for Assemblies, Modules and Hybrids Manufacturing

## 19 ED/EDA and Test and Measurement

- Computer Aided Design (CAD) Tools
- Computer Aided Engineering (CAE) Tools
- Electronic Automation Design (EDA) Environments Peripheral Equipments
- Laboratory and Scientific Equipment
- Electronic Design / Electronic Design Automation ( ED / EDA) Services
- Electronic Design / Electronic Design Automation ( ED / EDA) Systems Design and Development Services
- Electronic Design / Electronic Design Automation ( ED / EDA) Visual Inspection & Image Processing Services
- Electronic Design Services on Materials Test
- Electronic Design on Measurement Technology of Non-Electrical Parameters
- Electronic Design on Measurement Technology of Electrical Parameters
- ED / EDA Test and Measurement Systems
- Conveyors Test Adapters
- Laboratory Equipment & Supply

## 20 General Operation Aids and Production Subsystems

- Production Operation Aid for Metallic Preliminary Product & Semi-finished goods
- Production Operation Aid for Non-Metallic Preliminary Product & Semi-finished goods
- Production Operation Aid for Material Processing
- Production Operation Aid for Marking and Identification
- Production Operation Aid for Decontamination
- Production Operation Aid for Recirculation System
- Production Operation Aid for Precision Mechanic
- Production Operation Aids for Software and Fab Controlling Systems

## 21 Production-related Services

- Information & Communications Technology
- Production Management
- Manufacturing & Industrial Engineering
- Prototype Making
- Business Management & Consultancy Service

## Publishing Service

## Product Index of World of Display Technology

### D1 Displays

- 3D Visualisation Technology
- Display Production Engineering Services
- Display Unit & Accessories
- Field Emission Displays (FED)
- Holographic Displays
- Light Emitting Diode ( LED ) Displays
- Liquid Crystal Displays (TN, STN, TFTLCD)
- Microdisplay (Chip Based Displays), LCOS Displays, DMD Displays, Ferroelectric Liquid Crystal on Silicon Technology, etc.
- Miniature Displays, Poly-Silicon TFTLCDs Microdisplays
- Monitor for Customer Specific Application
- Monitor Assembly
- Peripheral Equipment for Professional Displays
- Photonics
- Plasma Display Panel (PDP)
- Organic Light Emitting Diode Display

- Retrofit Touch Screen
- Signaling & Illuminating Elements
- Visualisation Technology

### D2 Display Production (FPD)

- Clean Room Technology For Flat Display Production (FPD)
- Conveyors, Handling & Storage Technology For Flat Display Production (FPD)
- Flat-panel Display Semi-finished Good Production
- Flat-panel Display Processing Material Production
- LEM Technology
- Display Production Processing Material
- Personal Display Technology
- Production Equipment and System for FPD
- Remote Visualisation Technology
- Repairing Equipment for Display Technology
- Test & Measurement Technology For FPD Production
- Video Display Technology

Do you wish to exhibit at the World of Display Technology section?  Yes  No

## Product Index of World of Solar

### S Solar Photovoltaic

- Solar Photovoltaic Cogeneration Systems & Softwares
- Solar Photovoltaic Components
- Photovoltaic Wafers
- Concentrating Solar Photovoltaic ( CSP / CPV ) Product
- Solar Photovoltaic Cells
- Solar Photovoltaic Moulds & Modules
- Solar Photovoltaic Manufacturing Machinery (eg. Cleanliness ultrasonic bath)
- Rural PV Power Generation Systems
- Solar Photovoltaic Battery ( PV Battery )
- Solar Photovoltaic Battery ( PV Battery ) Machine
- Solar Photovoltaic Inspection & Control System
- Solar Thermal Technology
- Solar Photovoltaic System Technologies
- Inverters for Solar Photovoltaic Systems
- Solar Photovoltaic Tracking, Mounting & Installation Systems

Do you wish to exhibit at the World of Solar section?  Yes  No

(Total Number of Listings – 5 Free Listings) X US\$20 each = \*US\$ \_\_\_\_\_ Cost of Additional Listings (B)

## Part III Supplementary Information

Company Name: \_\_\_\_\_

Agent/Branch office in Hong Kong, if any:

Company: \_\_\_\_\_

Address: \_\_\_\_\_

Contact: \_\_\_\_\_ Tel.: \_\_\_\_\_ Fax.: \_\_\_\_\_

Are you an exhibitor in electronicAsia 2009?  Yes  No Booth No.: \_\_\_\_\_

## Part IV Online Promotions

Exhibitors can enjoy promotions at the fair website and hktcd.com. All applicants have to complete the enclosed "Information Submission Form for Online Promotions" and submit three product/service photos and information.

## Part V Additional Promotion Package - Enhanced Online Promotions

Please refer to the enclosed "Additional Promotion Package - Enhanced Online Promotions Order Form"

## Part VI Application Procedures

- Complete the application form, including the product index and supplementary information.
  - 50% non-refundable participation fee should be paid when submitting the application.
- (a) For companies from AUSTRALIA, THE CHINESE MAINLAND, HONG KONG, MALAYSIA AND THAILAND, please submit this application form and pay your participation fee to:  
**Hong Kong Trade Development Council**  
 Unit 13, Expo Galleria, HKCEC, 1 Expo Drive, Wanchai, Hong Kong  
 Tel: (852) 1830668 Fax: (852) 2824 0249 Email: exhibitions@hktdc.org
- (b) For companies from ALL OTHER COUNTRIES/REGIONS, please submit this application form and pay your participation fee to:  
**MMI Asia Pte Ltd**  
 20 Harbour Drive, #05-04 PSA Vista, Singapore 117612  
 Tel: (65) 6236 0988 Fax: (65) 6236 1966 Email: mmi\_sg@mmiasia.com.sg
- (c) For companies from EUROPE, please submit this application form to:  
**Messe Muenchen GmbH, Messengelände, 81823 München, Germany**  
 Tel: (49) 89 949 20325 Fax: (49) 89 949 9720325 Email: katrin.hirl@messe-muenchen.de
- Balance should be paid upon space confirmation or the deadline specified by the Organiser.

## Part VII Payment Arrangement

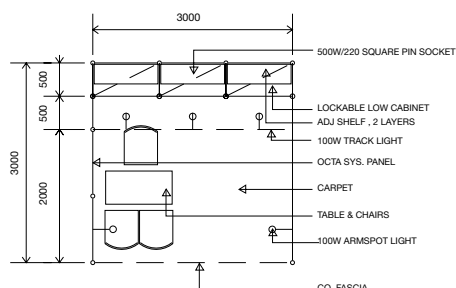
Participation Fee	US\$	
Booth Rental (A)		+
Cost of Additional Listing (B)		
<b>Total Fee Payable =</b>		

We have arranged our payment of US\$ \_\_\_\_\_

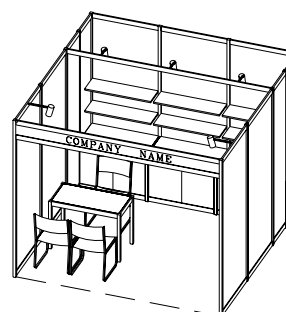
- by enclosing a \*bank draft/cross cheque with "electronicAsia 2010" written at the back and payable to:
- Hong Kong Trade Development Council  MMI Asia Pte Ltd
- by telegraphic transfer to
- HKTDC Account  
 Account No.: 006-391-17818761(for USD)  
 Account Name: Hong Kong Trade Development Council  
 Banker: Citibank, N.A., Hong Kong Branch
- MMI Account  
 Account No.: 417110 (for USD)  
 Account Name: MMI Asia Pte Ltd  
 Banker: The Bank of East Asia Limited, Singapore Branch  
 Swift Code: BEASSGSG
- All banking charges, if any, are to be borne by the exhibitor. Bank drafts should be drawn on banks in the United States. When arranging the remittance, please specify the name of exhibition: "electronicAsia 2010" and company name.
- \* Please delete whichever is inappropriate.

## Part VIII Booth Layout and Facilities

### 9sq.m. Standard Booth



Plan



Perspective